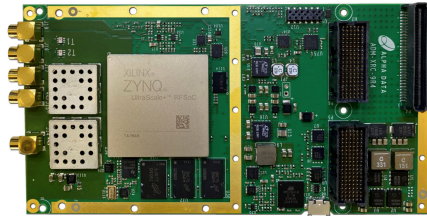


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Applications

- RF Signal Sampling/Generation
- Radar
- Beamforming
- MIMO (5G) communications Tx and Rx
- Signal Detection/Jamming

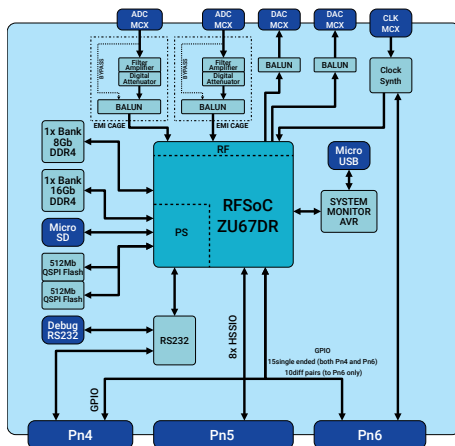
Summary

The **ADM-XRC-9R4** is a high performance System On Module (SOM) based on the AMD Xilinx Zynq Ultrascale+ RFSoc, which combines FPGA Fabric, ADC and DAC interfaces and ARM CPU cores in a single low-power device.

The module is provided in rugged XMC (or XMC+) format and is available in Industrial temperature grades with Air or Conduction Cooling.

Board Features

- 2x 14 bit 5.9GSPS RF-ADC
- 2x 14 bit 10GSPS RF-DAC
- Digital Front-End Hard-IP
- On-board microcontroller accessible via USB



Target Device

AMD Xilinx Zynq Ultrascale+ XCZU67DR-2 (FFVE1156)

FPGA Specification

Logic Cells = 489k
 DSPs = 1872
 BRAM = 22.8Mb URAM = 45Mb
 4x ARM® Cortex™-A53 MPCore™ - 1.5GHz
 2x ARM® Cortex™-R5 MPCore™ - 533MHz
 2x 14 bit 5.9GSPS RF-ADC
 2x 14 bit 10GSPS RF-DAC
 1x Digital Front-End Hard-IP

Application Data Memory

1x 16Gb DDR4-2400 - (to PS)
 1x 8Gb DDR4-2400 - (to PL)
 1x microSD

Configuration Memory

QSPI 2x512Mb Flash Memory

Configuration Modes

PS - Configured via QSPI or uSD

Deliverables

ADM-XRC-9R4 Board
 One Year Warranty
 One Year Technical Support

Input/Output Interfaces

High-Frequency Analogue Inputs

Dual 14-bit 5.9GSPS RF-ADC with an external low-pass filter - amplifier - digital attenuator - Balun (all bar the Balun is bypassable)

Resolution: 14-bit
 Max Sample Freq: 5.9Gsp/s
 Bandwidth: 625MHz-2815MHz (bypass the LPF and attenuators to increase the bandwidth)
 Impedance: 50Ω (AC coupled)
 Connector: MCX

High-Frequency Analogue Outputs

Dual 14-bit 10GSPS RF-DAC driving a Balun to the output connector

Resolution: 14-bit
 Max Sample Freq: 10Gsp/s
 Bandwidth: 625MHz-2815MHz
 Impedance: 50Ω (AC coupled)
 Connector: MCX

External Clock Input

External Clock Source

Bandwidth: 1MHz to 500MHz
 Impedance: 100Ω (AC coupled)
 Connector: MCX

High-Speed Serial IO

HSSIO Links - 10G Ethernet

Onboard USB Comms

USB Interface to system monitor

Low-Speed Serial IO

Serial Comms Ports

Low-Speed Digital IO

15x single ended signals (to both Pn4 and Pn6)
 10x differential pair signals (to Pn6 ONLY)

Support

TBC

Board Format

XMC (Switched Mezzanine Card, VITA 42) or XMC+ (VITA 88)

Environmental Specification

Cooling Option	Operating Temperatures		Storage Temperatures	
	Min	Max	Min	Max
AC1	-40°C	+70°C	-55°C	+100°C
CC1	-40°C	+70°C	-55°C	+100°C

Operating Humidity : Up to 95% (non-condensing)

EMC Standards

 FCC 47CFR Part 2
 EN55022:2010 Equipment ClassB

Conformal Coating Options

 Acrylic or Polyurethane
 Contact sales for specification of coatings.

Ordering Information
Order Code: ADM-XRC-9R4(x)(c)(a)

Option	Code	Description of Options
XMC+ Option	x	blank = Standard XMC connectors Fitted, /V88 = XMC+ connectors fitted
Cooling	c	/AC1 = air cooled industrial, /CC1 = conduction cooled industrial
Conformal Coating	a	blank = no conformal coating, A = Acrylic, P = Polyurethane
Note		Contact Sales for other options